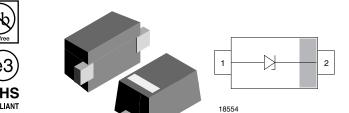


Vishay Semiconductors

Small Signal Schottky Diode

Features

- This diode features very low turn-on voltage and fast switching
- This device is protected by a PN junction guard ring against excessive voltage, such as electrostatic discharges
- Space saving SOD-523 package
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



Mechanical Data

Case: SOD-523

Weight: approx. 1.6 mg

Molding compound flammability rating:

UL 94 V-0

Terminals: high temperature soldering guaranteed:

260 °C/4 x 10 s at terminals Packaging codes/options:

GS18/10k per 13" reel (8 mm tape), 10k/box GS08/3k per 7" reel (8 mm tape), 15k/box

Parts Table

Part	Ordering code	Type marking	Remarks
BAT54-02V	BAT54-02V-GS18 or BAT54-02V-GS08	V	Tape and reel

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Repetitive peak reverse voltage = working peak reverse voltage		V_{RRM}	30	V
Forward continuous current		I _F	200	mA
Repetitive peak forward current		I _{FRM}	300	mA
Surge forward current		I _{FSM}	600	mA
Power dissipation		P _{tot}	230	mW

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Thermal Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Junction soldering point		R _{thJS}	100	K/W
Junction temperature		T _j	125	°C
Storage temperature range		T _{stg}	- 65 to + 150	°C

Electrical Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min.	Тур.	Max.	Unit
Reverse Breakdown voltage	100 μA pulses	$V_{(BR)}$	30			V
Leakage current	Pulse test t_p < 300 μ s, δ < 2 % at V_R = 25 V				2	μΑ
Forward voltage	I_F = 0.1 mA, t_p < 300 μ s, δ < 2 %	V _F			240	mV
	$I_F = 1 \text{ mA}, t_p < 300 \mu\text{s}, \delta < 2 \%$	V _F			320	mV
	$I_F = 10 \text{ mA}, t_p < 300 \mu\text{s}, \delta < 2 \%$	V _F			400	mV
	$I_F = 30 \text{ mA}, t_p < 300 \mu\text{s}, \delta < 2 \%$	V _F			500	mV
	$I_F = 100$ mA, $t_p < 300$ μs , $\delta < 2$ %	V _F			800	mV
Diode capacitance	V _R = 1 V, f = 1 MHz	C _D			10	pF
Reverse recovery time	I_F = 10 mA , I_R = 10 mA to I_R = 1 mA, R_L = 100 Ω	t _{rr}			5	ns

Typical Characteristics

T_{amb} = 25 °C, unless otherwise specified

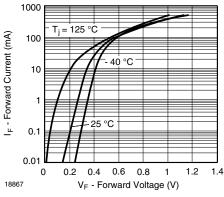


Figure 1. Typical Forward Voltage Forward Current vs. Various Temperatures

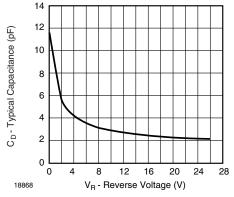


Figure 3. Typical Capacitance $^{\circ}$ C vs. Reverse Applied Voltage V_R

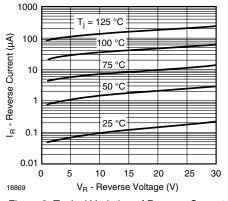
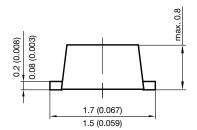


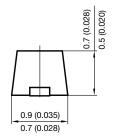
Figure 2. Typical Variation of Reverse Current vs. Various Temperatures

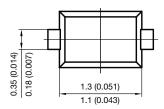


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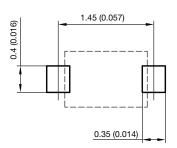
Package Dimensions in millimeters (inches): SOD-523







foot print recommendation:



Document no.: S8-V-3880.02-001 (4)

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